

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
CC2560ARVMR	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560A
CC2560ARVMR.Z	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560A
CC2560ARVMT	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560A
CC2560AYFVR.Z	NRND	Production	DSBGA (YFV) 54	5000 null	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	CC2560A
CC2560BRVMR	Active	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560B
CC2560BRVMR.Z	Active	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560B
CC2560BRVMT	Active	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-	CC2560B
CC2560BRVMT.Z	Active	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2560B
CC2560BYFVR	Active	Production	DSBGA (YFV) 54	2500 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-	CC2560B
CC2560BYFVR.Z	Active	Production	DSBGA (YFV) 54	2500 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	CC2560B
CC2560BYFVT	Active	Production	DSBGA (YFV) 54	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-	CC2560B
CC2560BYFVT.Z	Active	Production	DSBGA (YFV) 54	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	CC2560B
CC2564BRVMR	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564B
CC2564BRVMR.Z	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564B
CC2564BRVMT	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564B
CC2564BRVMT.Z	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564B
CC2564BYFVR.Z	Active	Production	DSBGA (YFV) 54	2500 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	See CC2564BYFVR	CC2564B
CC2564BYFVT.Z	Active	Production	DSBGA (YFV) 54	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	See CC2564BYFVT	CC2564B
CC2564NSRVMR	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564NSRVMT	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564RVVMR	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564RVVMR.Z	NRND	Production	VQFN-P-MR (RVM) 76	2500 LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564RVVMT	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564RVVMT.Z	NRND	Production	VQFN-P-MR (RVM) 76	250 SMALL T&R	Yes	SN	Level-3-260C-168 HR	-40 to 85	CC2564
CC2564YFVR.Z	NRND	Production	DSBGA (YFV) 54	5000 null	Yes	SAC396	Level-1-260C-UNLIM	-40 to 85	CC2564
CC2564YFVT.Z	NRND	Production	DSBGA (YFV) 54	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	CC2564

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

- (2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- (3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- (4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.